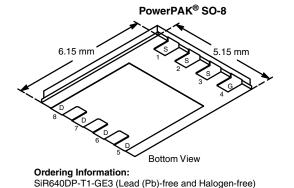


Vishay Siliconix

N-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)	
40	0.0017 at V _{GS} = 10 V	60	34.6 nC	
	0.0022 at V_{GS} = 4.5 V	60	34.0110	

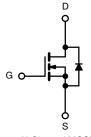


FEATURES

- TrenchFET[®] Power MOSFET
- Low Q_g for High Efficiency 100 % R_g and UIS Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Synchronous Rectification
- **DC/DC** Converter



N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	40	v	
Gate-Source Voltage		V _{GS}	± 20	- v	
	T _C = 25 °C		60 ^a		
Continuous Drain Current (T 150 °C)	T _C = 70 °C		60 ^a		
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C	I _D	45 ^{b, c}		
	T _A = 70 °C		36 ^{b, c}		
Pulsed Drain Current (t = 100 μs)		I _{DM}	350	— A	
Continuous Source-Drain Diode Current	T _C = 25 °C	1	60 ^a		
	T _A = 25 °C	I _S	5.6 ^{b, c}		
Single Pulse Avalanche Current		I _{AS}	40		
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	80	mJ	
Maximum Power Dissipation	T _C = 25 °C		104		
	T _C = 70 °C		66.6	w	
	T _A = 25 °C	P _D	6.25 ^{b, c}	vv	
	T _A = 70 °C		4 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		
Soldering Recommendations (Peak Temperature) ^{d, e}		Ŭ	260	°C	

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, f}	t ≤ 10 s	R _{thJA}	15	20	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	0.9	1.2	C/VV	

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under steady state conditions is 54 °C/W.

Document Number: 67190

For technical questions, contact: pmostechsupport@vishay.com

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	40			V
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 5.3		mV/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1		2.3	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$			1	
		V_{DS} = 40 V, V_{GS} = 0 V, T_{J} = 55 °C			10	μΑ
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.0014	0.0017	0
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.0018	0.0022	Ω
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		110		S
Dynamic ^b						
Input Capacitance	C _{iss}			4930		pF
Output Capacitance	C _{oss}	V_{DS} = 20 V, V_{GS} = 0 V, f = 1 MHz		3810		
Reverse Transfer Capacitance	C _{rss}			314		
Total Cata Charge	0	$V_{DS} = 20$ V, $V_{GS} = 10$ V, $I_D = 20$ A		75	113	nC
Total Gate Charge	Q _g			34.6	52	
Gate-Source Charge	Q _{gs}	V_{DS} = 20 V, V_{GS} = 4.5 V, I_{D} = 20 A		11		
Gate-Drain Charge	Q _{gd}			8.2		
Gate Resistance	Rg	f = 1 MHz	0.4	1.3	2.6	Ω
Turn-On Delay Time	t _{d(on)}			19	35	
Rise Time	t _r	V_{DD} = 20 V, R_L = 2 Ω		11	20	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ 10 A, V_{GEN} = 10 V, R_g = 1 Ω		50	90	
Fall Time	t _f			10	20	
Turn-On Delay Time	t _{d(on)}			46	90	ns
Rise Time	t _r	V_{DD} = 20 V, R_L = 2 Ω		88	170	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ 10 A, V_GEN = 4.5 V, R_g = 1 Ω		56	110	
Fall Time	t _f			25	50	
Drain-Source Body Diode Characteristic	s					
Continuous Source-Drain Diode Current	ا _S	$T_{C} = 25 \ ^{\circ}C$			60	٨
Pulse Diode Forward Current (t = $100 \ \mu s$)	I _{SM}				350	A
Body Diode Voltage	V _{SD}	I _S = 5 A		0.69	1.1	V
Body Diode Reverse Recovery Time	t _{rr}			83	160	ns
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 10 A, dl/dt = 100 A/μs, T _J = 25 °C		77	150	nC
Reverse Recovery Fall Time	t _a	$F = 10 A$, $a/at = 100 A/\mu s$, $T_{\rm J} = 25 C$		26		
Reverse Recovery Rise Time				57		ns

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

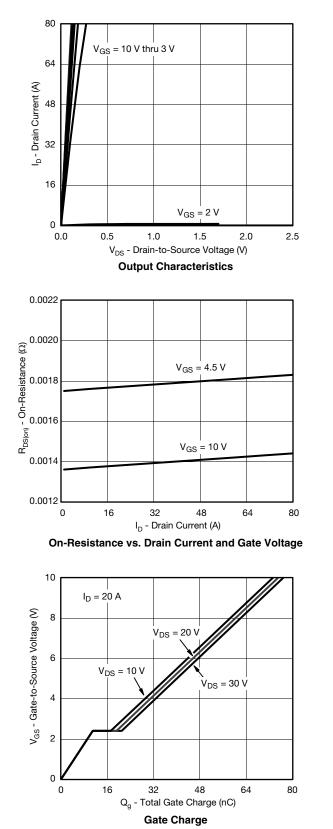
b. Guaranteed by design, not subject to production testing.

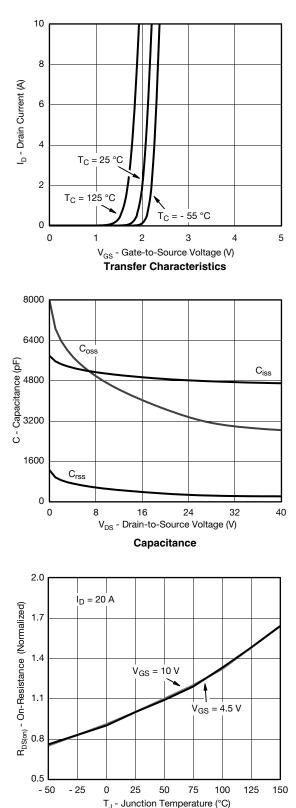
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





On-Resistance vs. Junction Temperature

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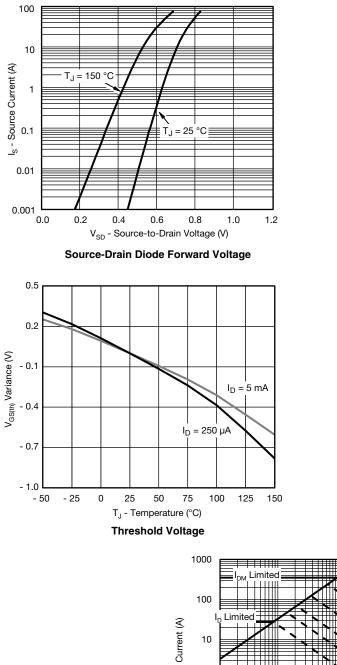
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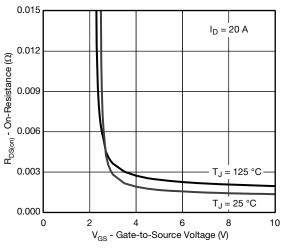
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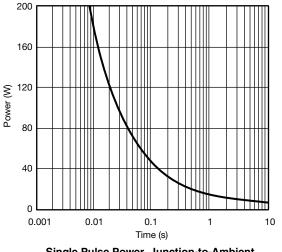


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

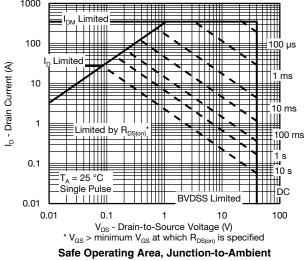




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

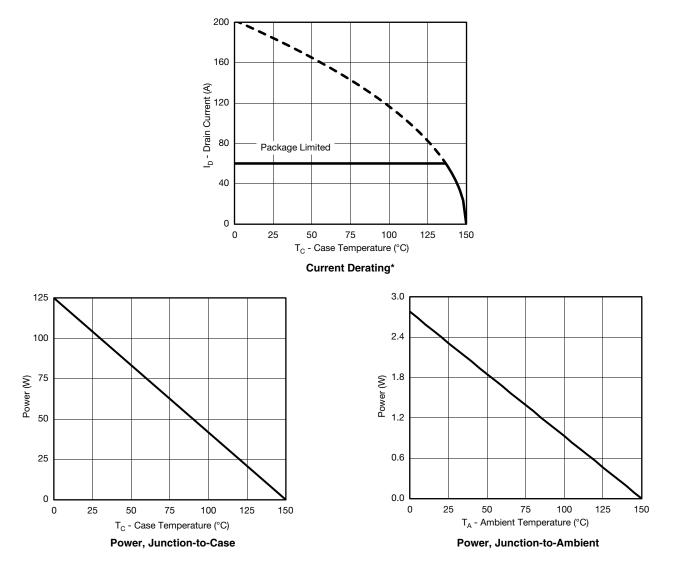


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SiR640DP Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

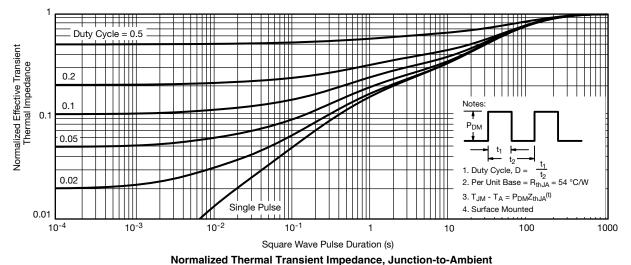


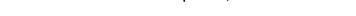
* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

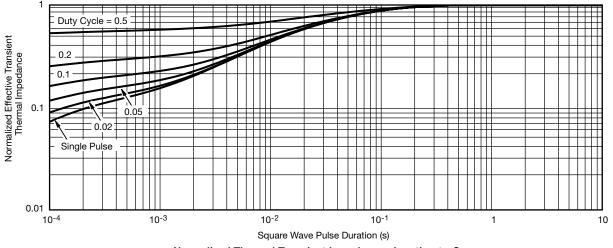


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







Normalized Thermal Transient Impedance, Junction-to-Case

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